## Type-C CC with High Speed Digital (HSD) Port Protection Switch

## FUSB252

## Description

The FUSB252 is an integrated port protection switch for USB Type- $\mathrm{C}^{\circledR}$ applications. This product will protect HSD+/and CCx pins when stressed with voltages up to 20 V . Over-Voltage Protection (OVP) at 5.8 V typical will protect the system for Electrical Overstress (EOS) damage. With a fully integrated USB 2.0 switch for HSD+/-, this product can be easily integrated into existing solutions. The HSD switches can pass USB 2.0 signals with bandwidth 1 GHz to maintain signal integrity and eye compliance.

The CC switches have very low RON of $0.3 \Omega$ to minimize signal attenuation. The FUSB252 also provides Dead Battery support per the Type-C specification Additional features include Under-Voltage Lockout (UVLO) and thermal shutdown.

## Features

- Fully Type-C Port Protection
- Supports USB Type-C Specification 1.2
- $\mathrm{V}_{\mathrm{CC}} 0 \mathrm{~V}-5.5 \mathrm{~V}$
- 20 V DC Protection on $\mathrm{V}_{\mathrm{CC}}$
- 16 V DC Protection on HSD Port
- $\mathrm{V}_{\mathrm{DD}}$ Operating Range, $2.7 \mathrm{~V}-5.5 \mathrm{~V}$
- Current Capability: 1 A
- CC R ON $0.3 \Omega$ Typical
- HSD R ${ }_{\mathrm{ON}}: 5 \Omega$ Typical
- Wide -3 db Bandwidth: 1 GHz
- Low Power Operation: $I_{C C}=9 \mu \mathrm{~A}$ Typical
- Dead Battery Support (UFP Support when No Power Applied)
- CC Over-Voltage Protection: Typical $=5.6 \mathrm{~V}$
- This is a $\mathrm{Pb}-$ Free Device


## Applications

- Smartphones
- Tablets
- Laptops



## UQFN16 $1.8 \times 2.6,0.4 P$

 CASE 523BF

ORDERING INFORMATION
See detailed ordering and shipping information on page 2 of this data sheet.

FUSB252


Figure 1. Typical Application

## ORDERING INFORMATION

| Part Number | Operating <br> Temperature Range | Package | Top Mark | Shipping $\dagger$ |
| :---: | :---: | :---: | :---: | :---: |
| FUSB252UMX | -40 to $85^{\circ} \mathrm{C}$ | 16-Lead Ultrathin Molded Leadless <br> Package (UMLP) $1.8 \times 2.6 \mathrm{~mm}$ | UZ | $5000 /$ Tape and Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

FUSB252
BLOCK DIAGRAM


Figure 2. Block Diagram

REFERENCE SCHEMATIC


Figure 3. Reference Schematic

## FUSB252

## PIN CONFIGURATIONS



Figure 4. Pin Assignment (Top Through View)


Figure 5. Pin Assignment (Bottom View)

## PIN DESCRIPTION

| Bump | Name | Type |  |
| :---: | :---: | :---: | :--- |
| POWER INTERFACE    <br> 13 VDD Power Power <br> 5,14 GND Ground Ground |  |  |  | | (14iption |
| :--- |

USB TYPE-C CONNECTOR INTERFACE INPUT

| 15,16 | VICC1, 2 | Input | Type C CC Interface OVP protection input, Connect to connector |
| :---: | :---: | :---: | :---: |

USB TYPE-C CONNECTOR INTERFACE OUTPUT

| 1,2 | VOCC1, 2 | Output | Type C CC Interface output. Connect to controller |
| :--- | :--- | :--- | :--- |

USB HIGH SPEED DATA INTERFACE

| 3 | HSD + | I/O | Common High Speed Digital / USB Data Bus |
| :---: | :---: | :---: | :--- |
| 4 | HSD- | I/O | Common High Speed Digital / USB Data Bus |
| 12 | HSD1+ | I/O | Multiplexed Source Input 1 |
| 11 | HSD1- | I/O | Multiplexed Source Input 1 |
| 10 | HSD2+ | I/O | Multiplexed Source Input 2 |
| 9 | HSD2- | I/O | Multiplexed Source Input 2 |

SIGNAL INTERFACE

| 7 | /OE | I/O | Switch Enable |
| :---: | :---: | :---: | :--- |
| 6 | SEL | I/O | Switch Select |
| 8 | INTB/FLAGB | Output | OVP Interrupt Flag |

FUSB252

Table 1. CC SWITCH TRUTH TABLE CONFIGURATION

| $V_{\text {DD }}$ |  |  |  | VICc Voltage | CC Switch Configuration |
| :---: | :---: | :--- | :---: | :---: | :---: |
| $0 \mathrm{~V}-$ UVLO (Not Valid) | $0 \mathrm{~V}-5.8 \mathrm{~V}$ | OFF Dead Battery Rd Inserted |  |  |  |
|  | 5.8 V to 20 V | OFF Dead Battery Rd Inserted |  |  |  |
| $2.7 \mathrm{~V}-5.5 \mathrm{~V}$ (Valid) | $0 \mathrm{~V}-5.8 \mathrm{~V}$ | On |  |  |  |
|  | 5.8 V to 20 V | OFF (OVP) |  |  |  |

Table 2. CC SWITCH TRUTH TABLE CONFIGURATION

| $/$ OE | SEL | VDD | HSD+ / HSD- | CC |
| :---: | :---: | :---: | :---: | :---: |
| 1 | 0 | Not Valid | $\times($ Open/High-Z $)$ | Dead Battery |
| 0 | 0 | Not Valid | $\times($ Open/High-Z $)$ | Dead Battery |
| 1 | $X$ | Valid | $\times($ Open/High-Z $)$ | On |
| 0 | 0 | Valid | HSD1+ / HSD1- | On |
| 0 | 1 | Valid | HSD2+ / HSD2- | On |

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter |  |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VVDD | Supply Voltage from V ${ }_{\text {DD }}$ |  |  | -0.5 | 12.0 | V |
| $\mathrm{V}_{\text {VICC }}$ | $V_{\text {ICCx }}$, to GND |  |  | -0.5 | 24 | V |
| $\mathrm{V}_{\text {SW }}$ | $\mathrm{V}_{\text {HSD } \pm}$, to GND |  |  | -5 | 16 | V |
| $\mathrm{V}_{\text {Occ }}, \mathrm{V}_{\text {SW }}$ | $\mathrm{V}_{\text {OCCx }} \mathrm{V}_{\text {HSDx }}$ to GND |  |  | -0.5 | 6 | V |
| $\mathrm{V}_{\text {CONTROL }}$ | DC Input Voltage (S, /OE) |  |  | -0.5 | $\mathrm{V}_{\text {VDD }}$ | V |
| ICCsw | DC CC Switch Current |  |  |  | 1.25 | A |
| lusbsw | DC Output Current |  |  |  | 100 | mA |
| $\mathrm{IIK}^{\prime}$ | DC Input Diode Current |  |  | -50 |  | mA |
| T Storage | Storage Temperature Range |  |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{J}$ | Maximum Junction Temperature |  |  |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| TL | Lead Temperature (Soldering, 10 seconds) |  |  |  | +260 | ${ }^{\circ} \mathrm{C}$ |
| ESD | IEC 61000-4-2 System ESD | Connector Pins $\left(\mathrm{V}_{\mathrm{VDD}}, \mathrm{V}_{\mathrm{ICCx}}, \mathrm{V}_{\mathrm{HSD} \pm}\right)$ | Air Gap | 15 |  | kV |
|  |  |  | Contact | 8 |  |  |
|  | IEC 61000-4-5 Surge ESD | $\mathrm{V}_{\text {ICCx }} \text { to GND }$ |  | -24 | 24 | V |
|  |  | $\mathrm{V}_{\mathrm{HSD} \pm} \text { to GND }$ |  | -16 | 16 | V |
|  | Human Body Model, JEDEC JESD22-A114 | Power to GND |  | 4 |  | kV |
|  |  | $\begin{aligned} & \text { External Pins to GND } \\ & \left(\mathrm{V}_{\text {HSD } \pm}, \mathrm{V}_{\text {ICCx }}\right) \end{aligned}$ |  |  |  |  |
|  |  | $\left.\begin{array}{l} \text { System Side Pin } \\ \left(V_{\text {HSDx } \pm}, V_{\text {OCCx }}, ~ S, ~ / O E, ~ F L A G B ~\right. \end{array}\right)$ |  | 2 |  |  |
|  | Charged Device Model, JEDEC LESD22-C101 | All Pins |  | 1 |  |  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{VDD}}$ | Supply Voltage | 2.7 | 4.2 | 5.5 | V |
| $V_{\text {ICC }}$ | Type C Input Voltage | 0 |  | 5.5 | V |
| $\mathrm{V}_{\text {OCC }}$ | Type C Output Voltage | 0 |  | 5.5 | V |
| ICCSW | Maximum CC Switch Current |  |  | 1 | A |
| $\mathrm{V}_{\text {CNTRL }}$ | Control Input Voltage (SEL, /OE) | -0.5 |  | $\mathrm{V}_{\mathrm{VDD}}$ | V |
| $V_{\text {SW }}$ | HSD/USB Switch I/O Voltage | -0.5 |  | 4.5 | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC CHARACTERISTICS (Unless otherwise specified: Recommended $T_{A}$ and $T_{J}$ temperature ranges. All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=4.2 \mathrm{~V}$ unless otherwise specified.)

|  | Characteristic | V D (V) | Conditions | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{J}}=-40^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \end{aligned}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol |  |  |  | Min | Typ | Max |  |

## BASIC OPERATION DEVICE

| $\mathrm{I}_{\mathrm{CC}}$ | Quiescent Supply Current | 2.7 to 5.5 | /OE $=\mathrm{L}, \mathrm{l}$ IOUT $=0$ | 9 | $\mu \mathrm{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $/ \mathrm{OE}=\mathrm{H}, \mathrm{l}$ IOUT $=0$ | 9 |  |
| IofF | Power-Off Leakage Current | 0 |  | 3 | $\mu \mathrm{A}$ |

BASIC OPERATION CC SWITCH

| $\mathrm{I}_{\text {SD(DB) }}$ | Dead Battery Supply Current | 0 to UVLO | Dead Battery State Supply Current |  | 15 |  | $\mu \mathrm{A}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| R ON | CC Path On Resistance | 2.7 to 5.5 | $\mathrm{l}_{\text {OUT }}=200 \mathrm{~mA}$ |  | 350 | 480 | $\mathrm{m} \Omega$ |
| Vov_trip | Input OVP Lockout | 2.7 to 5.5 | $V_{\text {ICC }}$ Rising |  | 5.65 | 6.20 | V |
|  |  |  | $V_{\text {ICC }}$ Falling |  | 5.3 |  |  |
| Vov_HYS | Input OVP Hysteresis | 2.7 to 5.5 |  |  | 0.35 |  | V |
| V UVLO | Under-Voltage Lockout | 2.7 to 5.5 | $\mathrm{V}_{\mathrm{DD}}$ Rising |  | 2.55 | 2.70 | V |
|  |  |  | $V_{\text {DD }}$ Falling |  | 2.5 |  |  |
| TSD | Thermal Shutdown (Note 1) |  | Shutdown Threshold |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
|  |  |  | Return from Shutdown |  | 130 |  |  |
|  |  |  | Hysteresis |  | 20 |  |  |
| Rd | Dead Battery Pull-Down Resistance | 0 to UVLO | Dead Battery Resistance | 4.08 | 5.10 | 6.12 | k $\Omega$ |
|  |  |  | Voltage on Pin | 0.25 |  | 2.6 | V |

BASIC OPERATION HSD SWITCH

| Vov_TRIP | Input OVP Lockout | 2.7 to 5.5 | $\mathrm{V}_{\text {HSD } \pm \text { Rising }}$ |  | 4.4 | 5.0 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\text {HSD } \pm}$ Falling |  | 4.1 |  |  |
| Vov_HYS | Input OVP Hysteresis | 2.7 to 5.5 |  |  | 0.3 |  | V |
| VUV_TRIP | Input Under-Voltage Lockout | 2.7 to 5.5 |  |  | -1.2 |  | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input Voltage High | 2.7 to 5.5 |  | 1.3 |  |  | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Input Voltage Low | 2.7 to 5.5 |  |  |  | 0.5 | V |
| $\mathrm{I}_{\mathrm{N}}$ | Control Input Leakage | 2.7 to 5.5 | $\mathrm{V}_{\text {SW }}=0$ to $\mathrm{V}_{\mathrm{DD}}$ |  | 0.1 |  | $\mu \mathrm{A}$ |
| Ioz | Off State Leakage | 4.2 | $0 \leq \mathrm{HSDn} \leq 3.6 \mathrm{~V}$ |  | 2 |  | $\mu \mathrm{A}$ |
|  |  | 4.2 | $$ |  | 100 |  | nA |
| R ${ }_{\text {ON }}$ | HS Switch On Resistance | 4.2 | $\mathrm{V}_{\mathrm{SW}}=0.4 \mathrm{~V}, \mathrm{I}_{\mathrm{ON}}=-8 \mathrm{~mA}$ |  | 5 |  | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ | HS Delta R ${ }_{\text {ON }}$ | 4.2 | $\mathrm{V}_{\mathrm{SW}}=0.4 \mathrm{~V}, \mathrm{I}_{\mathrm{ON}}=-8 \mathrm{~mA}$ |  | 0.1 |  | $\Omega$ |

1. Guaranteed by characterization, not production tested.

AC CHARACTERISTICS (Unless otherwise specified: Recommended $T_{A}$ and $T_{J}$ temperature ranges. All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{DD}}=3.8 \mathrm{~V}$ unless otherwise specified.)

|  | Characteristic | $\mathrm{V}_{\mathrm{DD}}(\mathrm{V})$ | Conditions | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C} \text { to }+85^{\circ} \mathrm{C} \\ & \mathrm{~T}_{\mathrm{J}}=-40^{\circ} \mathrm{C} \text { to }+125^{\circ} \mathrm{C} \end{aligned}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol |  |  |  | Min | Typ | Max |  |

CC SWITCH TIMING PARAMETER

| tovP | Response Time (Note 2) | 2.7 to 5.5 | IOUT $=0.2 \mathrm{~A}, \mathrm{C}_{\mathrm{L}}=200 \mathrm{pF}$, <br> $\mathrm{V}_{\text {ICCx }} 5 \mathrm{~V}$ to 6 V | 0.5 | 1.0 | $\mu \mathrm{~s}$ |  |
| :---: | :--- | :---: | :--- | :--- | :---: | :---: | :---: |
| ton | Turn-On Time |  | $V_{\mathrm{DD}}$ Rising 2 V to 3 V |  | 25 |  | ms |
| $\mathrm{~T}_{\text {MBB }}$ | Make-Before-Break | 2.7 to 5.5 | $\mathrm{~V}_{\mathrm{DD}}$ Rising 2 V to 3 V |  | 600 |  | ns |

CC SWITCH CAPACITANCE

| $\mathrm{C}_{\mathrm{ON}}$ | Switch Path On Capacitance (Note 2) | 2.7 to 5.5 |  |  | 100 |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

CC SWITCH BANDWIDTH

| BW | PD Traffic Bandwidth (Note 2) | 2.7 to 5.5 | $R_{L}=50 \Omega, C_{L}=200 \mathrm{pF}$ |  | 25 |  | MHz |
| :---: | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

HSD SWITCH TIMING PARAMETER

| tovp | Response Time (Note 2) | 2.7 to 5.5 | IOUT $=0.2 \mathrm{~A}, \mathrm{~V}_{\mathrm{D} \pm} 4 \mathrm{~V}$ to 5 V | 0.5 | 1.0 | $\mu \mathrm{s}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ton | Turn-On Time, /OE to Output (Note 2) | 2.7 to 5.5 | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \\ & \mathrm{~V}_{\mathrm{SW}}=0.8 \mathrm{~V} \end{aligned}$ | 25 |  | ms |
| tofF | Turn-Off Time, /OE to Output (Note 2) | 2.7 to 5.5 | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \\ & \mathrm{~V}_{\mathrm{SW}}=0.8 \mathrm{~V} \end{aligned}$ | 100 | 400 | ns |
| $\mathrm{t}_{\text {PD }}$ | Propagation Delay (Note 2) | 2.7 to 5.5 | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ | 0.25 |  | ns |
| $\mathrm{T}_{\text {BBM }}$ | Break-Before-Make (Note 2) | 2.7 to 5.5 | $\begin{aligned} & R_{L}=50 \Omega, C_{L}=5 \mathrm{pF}, \\ & V_{S W x}=0.8 \mathrm{~V} S E L=H \leftrightarrow L \end{aligned}$ | 100 |  | $\mu \mathrm{S}$ |
| $\mathrm{O}_{\text {IRR }}$ | Off Isolation | 2.7 to 5.5 | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=240 \mathrm{MHz}$ | -25 |  | dB |
| Xtalk | Non-Adjacent Channel Crosstalk | 2.7 to 5.5 | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=240 \mathrm{MHz}$ | -40 |  | dB |

HSD SWITCH CAPACITANCE

| $\mathrm{C}_{\mathrm{IN}}$ | Control Pin Input Capacitance (Note 2) | 0 |  | 1.5 | pF |
| :---: | :--- | :--- | :--- | :---: | :---: |
| $\mathrm{C}_{\mathrm{ON}}$ | $\mathrm{HSD}+/ \mathrm{HSD}-$ On Capacitance (Note 2) | 2.7 to 5.5 | $/ \mathrm{OE}=\mathrm{L}, \mathrm{f}=240 \mathrm{MHz}$ |  | 4 |
| $\mathrm{C}_{\mathrm{OFF}}$ | HSD1x / HSD2x Off Capacitance <br> (Note 2) | 2.7 to 5.5 | $/ \mathrm{OE}=\mathrm{H}$ | pF |  |

USB SWITCH BANDWIDTH

| BW | -3 db Bandwidth (Note 2) | 2.7 to 5.5 | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}$ |  | 1400 |  | MHz |
| :---: | :---: | :---: | :--- | :--- | :--- | :--- | :--- |
|  | 2.7 to 5.5 | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ |  | 560 |  |  |  |

USB HIGH-SPEED-RELATED

| $\mathrm{t}_{\text {SK( }(P)}$ | Skew of Opposite Transitions <br> of the Same Output (Note 2) | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$ |  | 25 |  | ps |
| :---: | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{t}_{\mathrm{J}}$ | Total Jitter (Note 2) |  | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}$, <br> $\mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=500 \mathrm{ps}(10-90 \%)$ at <br> $480 \mathrm{Mbps}\left(\mathrm{PRBS}=2^{15}-1\right)$ | 200 |  | ps |

2. Guaranteed by characterization, not production tested.

## OPERATION AND APPLICATION DESCRIPTION

## Out of Spec Surge/Spike Voltage due to Hot Plug

The FUSB252 protects end systems against 20 V DC on the CC pin, in cases where the FUSB252 is tested to mimic a hot plug event, a fully charged cable connected to a power supply set to 20 V is used to zap the VICC pins of the device. In these cases, the inductance of the cable causes voltage spikes that are higher than the absolute maximum ratings of the of the VICC pins. These voltages can cause damage to the VOCC pins. This scenario does not occur in normal usage. The Type-C specification prevents the plug from having 20 V on VBUS from a PD source prior to a PD contract being completed. When the 20 V potential is on VBUS and shorted to the CC pin, it causes a detach and the voltage spikes are less likely to occur. The following reference circuit is required when the application calls for additional protection to protect against such event as hot plug.

## Application Specific Schematic

- Place a 5 V to 6 V rated Zener TVS diode such as (CZRF52C5V6 or CD1005-Z5V1) on the VOCC pin, and a $5 \Omega$ resistor to device ground to prevent the FUSB252 from being damaged during these tests. With this additional protection if is also important to select the right external VICC IEC TVS for the best overall performance.
- Without the additional protection the device by itself can withstand up to 9 V under the same hot plug condition.


Figure 6. Reference Schematic

## Over-Voltage Protection

When over-voltage event is detected, device will activate OVP to shutdown the switch within $t_{\mathrm{OVP}}$, as well as signal the FLAGB to indicate there is OV event to the system.

## Fault Reporting

Upon the detection of an over-voltage event, the INTB/FLAGB signals the fault by activating LOW.

## Type-C Solution Reference



Figure 7. Example of Type-C Solution Reference (SBU)


Figure 8. Example of Type-C Solution Reference (USB)

## TEST DIAGRAMS



$$
\mathrm{R}_{\mathrm{ON}}=\mathrm{V}_{\mathrm{ON}} / \mathrm{I}_{\mathrm{ON}}
$$

Figure 9. On Resistance


NOTE: $\quad R_{L}, R_{S}$, and $C_{L}$ are functions of the application environment (see AC Tables for specific values) $C_{L}$ includes test fixture and stray capacitance.

Figure 11. AC Test Circuit Load


Figure 13. Propagation Delay ( $\mathrm{t}_{\mathrm{R}} \mathrm{t}_{\mathrm{F}}-\mathbf{5 0 0} \mathrm{ps}$ )


NOTE: Each switch port is tested separately.

Figure 10. Off Leakage


Figure 12. Turn-On / Turn-Off Waveforms


Figure 14. Intra-Pair Skew Test $\mathbf{t}_{\text {SK(P) }}$

## TEST DIAGRAMS (continued)



Figure 15. Break-Before-Make Interval Timing


NOTE: $\quad R_{S}$ and $R_{T}$, are functions of the application environment (see AC Tables for specific values)


Off isolation $=20$ Log $\left(\mathrm{V}_{\text {OUT }} / \mathrm{V}_{\text {IN }}\right)$
NOTE: $\quad R_{S}$ and $R_{T}$, are functions of the application environment (see AC Tables for specific values)

Figure 16. Bandwidth
Figure 17. Channel Off Isolation


Figure 18. Non-Adjacent Channel-to-Channel Crosstalk


Figure 19. Channel Off Capacitance


Figure 20. Channel On Capacitance

FUSB252

USB, USB-C, USB Type-C and the USB logos are registered trademarks of USB Implementers Forum, Inc. onsemi is licensed by the Philips Corporation to carry the $\mathrm{I}^{2} \mathrm{C}$ bus protocol.


SIDE VIEW


BOTTOM VIEW

UQFN16 1.80×2.60×0.50, 0.40P
CASE 523BF
ISSUE A
DATE 06 MAY 2024
NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M-2018.
2. ALL DIMENSIONS ARE IN MILLIMETERS, DEGREES IN ANGLE.
3. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
4. TERMINAL SHAPE MAY VARY ACCORDING TO PACKAGE SUPPLIER, SEE TERMINAL SHAPE VARIANTS.


| DIM | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: |
|  | MIN | NOM | MAX |
| A | 0.45 | 0.50 | 0.55 |
| A1 | 0.00 | --- | 0.05 |
| A3 | 0.10 | 0.15 | 0.20 |
| b | 0.15 | 0.20 | 0.25 |
| D | 1.80 BSC |  |  |
| E | 2.60 BSC |  |  |
| e | 0.40 BSC |  |  |
| L | 0.35 | 0.40 | 0.45 |
| L4 | 0.45 | 0.50 | 0.55 |
| ToLERANCES FOR FEATURE CONTROL FRAME |  |  |  |
| aaa | 0.05 |  |  |
| bbb | 0.10 |  |  |
| ccc | 0.10 |  |  |
| ddd | 0.05 |  |  |
| eee | 0.05 |  |  |




RECOMMENDED MOUNTING FOOTPRINT* *FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

| DOCUMENT NUMBER: | 98AON13709G | Electronic versions are uncontrolled except when accessed directly from the Document Repository. <br> Printed versions are uncontroled except when stamped "CONTROLLED COPY" in red. |
| ---: | :--- | :--- | :--- |
| DESCRIPTION: | UQFN16 1.80x2.60x0.50, 0.40P | PAGE 1 OF 1 |

[^0]onsemi, OnSeMi., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application, Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that onsemi was negligent regarding the design or manufacture of the part. onsemi is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner

## ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:
Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support
For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales


[^0]:    onsemi and OnSemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

